WHAT IS CLAIMED IS:

| 1 | 1. | A me | ethod for measuring a position of a micro machined optical element, comprising: | | |
|---|----|------|---|--|--|
| 2 | | a) | disposing at least one magnetic sensor on the micro machined optical element; | | |
| 3 | | b) | exposing the at least one magnetic sensor to a magnetic field; and | | |
| 4 | | c) | measuring a change in a property of the at least one magnetic sensor as the | | |
| 5 | | | position of the micro machined optical element changes. | | |
| 1 | | 2. | The method of claim 1 wherein the magnetic sensor senses a magnetic field | | |
| 2 | | | that is used to actuate the micro machined optical element. | | |
| 1 | | 3. | The method of claim 1 wherein the micro machined optical element includes a | | |
| 2 | | | moveable portion and the at least one magnetic sensor is disposed on the | | |
| 3 | | | moveable portion. | | |
| 1 | | 4. | The method of claim 3 wherein the at least one magnetic sensor is selected | | |
| 2 | | | from the group consisting of, magneto resistive sensors, giant | | |
| 3 | | | magnetoresistance sensors, colossal magnetoresistance sensors, anisotropic | | |
| 4 | | | magnetoresistance sensors, magnetic tunnel junction devices, Hall effect | | |
| 5 | | | sensors, flux sensing coils, magnetostriction sensors and magneto optic | | |
| 6 | | | sensors. | | |
| 1 | | 5. | The method of claim 3 wherein the micro machined optical element includes a | | |
| 2 | | | fixed portion and at least one sensor further includes one or more magnetic | | |
| 3 | | | sensors disposed on the fixed portion. | | |
| 1 | | 6. | The method of claim 5 wherein the magnetic sensor disposed on the fixed | | |
| 2 | | | portion is disposed on a sidewall of the fixed portion. | | |
| 1 | | 7. | The method of claim 5 wherein the fixed portion includes a base and the | | |
| 2 | | | magnetic sensor that is disposed on the fixed portion is disposed on the base. | | |
| 1 | | 8. | The method of claim 5 wherein the fixed portion includes a top chip and the | | |
| 2 | | | sensor is disposed on the top chip. | | |



| 1 | 9. | The method of claim 5 wherein the sensor that is disposed on the movable |
|-----|-----|--|
| 2 | | portion and the sensor that is disposed on the fixed portion are electrically |
| 3 | | coupled in a bridge circuit |
| 1 2 | 10. | The method of claim 9 wherein the bridge circuit is a Wheatstone bridge circuit. |
| 1 | 11. | The method of claim 1 wherein the magnetic sensor senses a sense magnetic |
| 2 | | field that is separate from a magnetic field that actuates the micro machined |
| 3 | | optical element. |
| 1 | 12. | The method of claim 11, wherein a magnetic structure disposed on the micro |
| 2 | | machined optical element creates or changes the magnitude or direction of the |
| 3 | | sense magnetic field. |
| 1 | 13. | The method of claim 12, wherein the at least one magnetic sensor is selected |
| 2 | | from the group consisting of, magneto resistive sensors, giant |
| 3 | | magnetoresistance sensors, colossal magnetoresistance sensors, anisotropic |
| 4 | | magnetoresistance sensors, magnetic tunnel junction devices, Hall effect |
| 5 | | sensors, flux sensing coils, magnetostriction sensors and magneto optic |
| 6 | | sensors. |
| 1 | 14. | The method of claim 12 wherein the at least one magnetic sensor includes a |
| 2 | | magnetoresistive sensor characterized by a serpentine shape. |
| 1 | 15. | The method of claim 12 wherein the at least one magnetic sensor includes two |
| 2 | | or more magnetic sensors. |
| 1 | 16. | The method of claim 15 wherein the two or more sensors are coupled together |
| 2 | | in a bridge circuit. |
| 1 | 17. | The method of claim 16 wherein the bridge circuit is a Wheatstone bridge |
| 2 | | circuit. |
| 1 | 18. | The method of claim 11 wherein the micro machined optical element includes |
| 2 | | a moveable portion wherein the moveable portion is moveable with respect to |
| 3 | | an axis. |

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|--|---|-----|-------|--|
| 201 | 1 | | 19. | The method of claim 18 wherein the magnetic material is disposed |
| | 2 | | | substantially parallel to the axis. |
| | 1 | | 20. | The method of claim 19 wherein the at least one sensor includes a |
| | 1 | | 20. | |
| | 2 | | | magnetoresistive sensor; |
| | 3 | | | wherein the magnetoresistive sensor has a "C" shape having a gap; |
| •• | 4 | | | wherein, in at least one position of the moveable element, the magnetic |
| | 5 | | | material is disposed within the gap. |
| (34 | 1 | | 21. | The method of claim 18 wherein the magnetic material is disposed |
| どろ | 2 | | | substantially perpendicular to the axis. |
| | | | | |
| | 1 | | 22. | The method of claim 21 wherein the at least one sensor includes a |
| क्षः सम्ब | 2 | | | magnetoresistive sensor; |
| td tj | 3 | | | wherein the magnetoresistive sensor has a "C" shape having a gap; |
| | 4 | | | wherein, in at least one position of the moveable element, the magnetic |
| rest of the flow o | 5 | | | material is disposed within the gap. |
| e in the second | | | | · |
| 1,24 1,24 | 1 | | 23. | The method of claim 1, further comprising: |
| 61 and 61 | 2 | | | measuring a temperature; and |
| | 3 | | | compensating for a change in the property of the at least one magnetic sensor |
| | 4 | | | with temperature. |
| | 1 | | 24. | The method of claim 23, wherein the compensating step includes determining |
| į.i. | 2 | | 27. | a relationship between the property of the magnetic sensor and the measured |
| | 3 | | | |
| | 5 | | | temperature. |
| | 1 | | 25. | The method of claim 23, wherein the compensating step includes regulating |
| | 2 | | | the temperature to maintain the temperature within a desired range. |
| | | | | |
| | 1 | 26. | A met | thod for measuring the position of a micro machined optical element, the micro |
| | 2 | | machi | ined optical element having at least one magnetic sensor, the method |
| | 3 | | comp | rising: |
| | 4 | | a) | exposing the at least one magnetic sensor to a magnetic field; and |
| | 5 | | b) | measuring a change in a property of the at least one magnetic sensor as a |
| | 6 | | | position of the micro machined optical element changes. |
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- The method of claim 26, further comprising:
 measuring a temperature; and
 compensating for a change in the property of the at least one magnetic sensor
 with temperature.

 The method of claim 27, wherein the compensating step includes determining
 - 28. The method of claim 27, wherein the compensating step includes determining a relationship between the property of the magnetic sensor and the measured temperature.
 - 29. The method of claim 27, wherein the compensating step includes regulating the temperature to maintain the temperature within a desired range.